

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/593,137 Confirmation No. 6494
Applicant(s) : OKUBO, et al.
Filed : Sept. 18, 2006
TC/A.U. : 1796
Examiner : FINK, Briann R.
Title : RESIN COMPOSITION AND SEMICONDUCTOR DEVICE
PRODUCED BY USING THE SAME

Docket No. : 033036.110
Customer No. : 25461

MAIL STOP AMENDMENT

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450
Sir:

AMENDMENT

This is in response to the Office Action of July 10, 2009 relating to the above-identified application.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 13 of this paper.

Attachments: Declaration